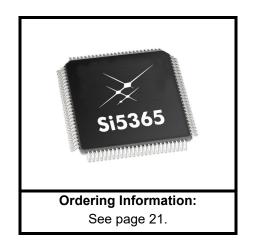


## PIN-PROGRAMMABLE PRECISION CLOCK MULTIPLIER

#### **Features**

- Not recommended for new designs. For alternatives, see the Si533x family of products.
- Selectable output frequencies ranging from 19.44 to 1050 MHz
- Low jitter clock outputs w/jitter generation as low as 0.6 ps rms ■ Pin-programmable settings (50 kHz-80 MHz)
- Integrated loop filter with selectable loop bandwidth (150 kHz to 1.3 MHz)
- Four clock inputs w/manual or automatically controlled switching

- Five clock outputs with selectable signal format (LVPECL, LVDS, CML, CMOS)
- Support for ITU G.709 FEC ratios (255/238, 255/237, 255/236)
- LOS alarm outputs
- On-chip voltage regulator for 1.8 ±5%, 2.5 V ±10%, or 3.3 V ±10% operation
- Small size: 14 x 14 mm 100-pin **TQFP**
- Pb-free, RoHS compliant



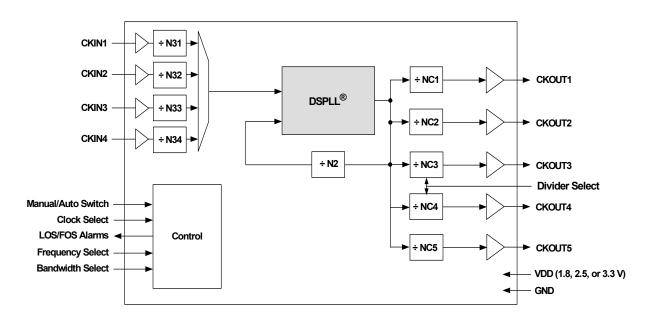
## **Applications**

- SONET/SDH OC-48/STM-16 and STM-64/OC-192 line cards
- GbE/10GbE, 1/2/4/8/10GFC line cards
- ITU G.709 line cards
- Test and measurement

### **Description**

The Si5365 is a low-jitter, precision clock multiplier for high-speed communication systems, including SONET OC-48/OC-192, Ethernet, and Fibre Channel, in which the application requires clock multiplication without jitter attenuation. The Si5365 accepts four clock inputs ranging from 19.44 to 707 MHz and generates five frequency-multiplied clock outputs ranging from 19.44 to 1050 MHz. The input clock frequency and clock multiplication ratio are selectable from a table of popular SONET, Ethernet, and Fibre Channel frequencies. The Si5365 is based on Skyworks Solutions' 3rd-generation DSPLL® technology, which provides any-frequency synthesis in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The DSPLL loop bandwidth is digitally programmable, providing jitter performance optimization at the application level. Operating from a single 1.8, 2.5, or 3.3 V supply, the Si5365 is ideal for providing clock multiplication in high performance timing applications.

# **Functional Block Diagram**



# TABLE OF CONTENTS

Section	Page
1. Electrical Specifications	4
2. Typical Application Schematic	
3. Functional Description	
3.1. Further Documentation	
4. Pin Descriptions: Si5365	
5. Ordering Guide	
6. Package Outline: 100-Pin TQFP	
7. PCB Land Pattern	
8. Top Marking	
8.1. Si5365 Top Marking	
8.2. Top Marking Explanation	
Document Change List	
Contact Information	

# 1. Electrical Specifications

**Table 1. DC Characteristics** 

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V } \pm 10\%, T_A = -40 \text{ to } 85 \text{ °C})$ 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Supply Current <sup>1</sup>	I <sub>DD</sub>	LVPECL Format 622.08 MHz Out All CKOUTs Enabled	_	394	435	mA
		LVPECL Format 622.08 MHz Out 1 CKOUT Enabled	_	253	294	mA
		CMOS Format 19.44 MHz Out All CKOUTs Enabled	_	278	321	mA
		CMOS Format 19.44 MHz Out 1 CKOUT Enabled	_	229	261	mA
		Disable Mode	_	165	_	mA
CKINn Input Pins <sup>2</sup>					1	
Input Common Mode Voltage (Input Thresh-	V <sub>ICM</sub>	1.8 V ± 5%	0.9	_	1.4	V
old Voltage)		2.5 V ± 10%	1	_	1.7	V
		3.3 V ± 10%	1.1	_	1.95	V
Input Resistance	CKN <sub>RIN</sub>	Single-ended	20	40	60	kΩ
Single-Ended Input Voltage Swing	V <sub>ISE</sub>	f <sub>CKIN</sub> < 212.5 MHz See Figure 1.	0.2	_	_	V <sub>PP</sub>
(See Absolute Specs)		f <sub>CKIN</sub> > 212.5 MHz See Figure 1.	0.25	_	_	V <sub>PP</sub>
Differential Input Voltage Swing	V <sub>ID</sub>	f <sub>CKIN</sub> < 212.5 MHz See Figure 1.	0.2	_	_	V <sub>PP</sub>
(See Absolute Specs)		fCKIN > 212.5 MHz See Figure 1.	0.25	_	_	V <sub>PP</sub>

- 1. Current draw is independent of supply voltage
- 2. No under- or overshoot is allowed.
- 3. LVPECL outputs require nominal VDD ≥ 2.5 V.
- **4.** This is the amount of leakage that the 3-Level inputs can tolerate from an external driver. See Si53xx Family Reference Manual for more details.
- 5. LVPECL, CML, LVDS and low-swing LVDS measured with Fo = 622.08 MHz.

**Table 1. DC Characteristics (Continued)** 

 $(V_{DD}$  = 1.8 ± 5%, 2.5 ±10%, or 3.3 V ±10%,  $T_A$  = -40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit			
Output Clocks (CKOUTn) <sup>3</sup>									
Common Mode	CKO <sub>VCM</sub>	LVPECL 100 $\Omega$ load lineto-line	V <sub>DD</sub> – 1.42	_	V <sub>DD</sub> –1.25	V			
Differential Output Swing	CKO <sub>VD</sub>	LVPECL 100 $\Omega$ load lineto-line	1.1	_	1.9	V <sub>PP</sub>			
Single Ended Output Swing	CKO <sub>VSE</sub>	LVPECL 100 $\Omega$ load lineto-line	0.5	_	0.93	V <sub>PP</sub>			
Differential Output Voltage	CKO <sub>VD</sub>	CML 100 $\Omega$ load line-to-line	350	425	500	$mV_{PP}$			
Common Mode Output Voltage	CKO <sub>VCM</sub>	CML 100 $\Omega$ load line-to-line	_	V <sub>DD</sub> -0.36	_	V			
Differential Output Voltage	CKO <sub>VD</sub>	LVDS 100 $\Omega$ load line-to-line	500	700	900	$mV_PP$			
		Low Swing LVDS 100 $\Omega$ load line-to-line	350	425	500	$mV_{PP}$			
Common Mode Output Voltage	CKO <sub>VCM</sub>	LVDS 100 $\Omega$ load line-to-line	1.125	1.2	1.275	V			
Differential Output Resistance	CKO <sub>RD</sub>	CML, LVPECL, LVDS	_	200	_	Ω			
Output Voltage Low	CKO <sub>VOLLH</sub>	CMOS	_	_	0.4	V			
Output Voltage High	CKO <sub>VOHLH</sub>	V <sub>DD</sub> = 1.71 V CMOS	0.8 x V <sub>DD</sub>	_	_	V			
Output Drive Current (CMOS driving into	CKO <sub>IO</sub>	V <sub>DD</sub> = 1.8 V	_	7.5	_	mA			
CKO <sub>VOL</sub> for output low or CKO <sub>VOH</sub> for output high. CKOUT+ and CKOUT– shorted externally)		V <sub>DD</sub> = 3.3 V	_	32	_	mA			

- 1. Current draw is independent of supply voltage
- 2. No under- or overshoot is allowed.
- **3.** LVPECL outputs require nominal VDD ≥ 2.5 V.
- **4.** This is the amount of leakage that the 3-Level inputs can tolerate from an external driver. See Si53xx Family Reference Manual for more details.
- **5.** LVPECL, CML, LVDS and low-swing LVDS measured with Fo = 622.08 MHz.

**Table 1. DC Characteristics (Continued)** 

 $(V_{DD}$  = 1.8 ± 5%, 2.5 ±10%, or 3.3 V ±10%,  $T_A$  = -40 to 85 °C)

Parameter	Symbol	<b>Test Condition</b>	Min	Тур	Max	Unit
2-Level LVCMOS Inpu	ut Pins					
Input Voltage Low	V <sub>IL</sub>	V <sub>DD</sub> = 1.71 V	_	_	0.5	V
		V <sub>DD</sub> = 2.25 V	_	_	0.7	V
		V <sub>DD</sub> = 2.97 V	_	_	0.8	V
Input Voltage High	V <sub>IH</sub>	V <sub>DD</sub> = 1.89 V	1.4	_	_	V
		V <sub>DD</sub> = 2.25 V	1.8	_	_	V
		V <sub>DD</sub> = 3.63 V	2.5	_	_	V
3-Level Input Pins <sup>4</sup>	1					
Input Voltage Low	V <sub>ILL</sub>		_	_	0.15 x V <sub>DD</sub>	V
Input Voltage Mid	V <sub>IMM</sub>		0.45 x V <sub>DD</sub>	_	0.55 x V <sub>DD</sub>	V
Input Voltage High	V <sub>IHH</sub>		0.85 x V <sub>DD</sub>	_	_	V
Input Low Current	I <sub>ILL</sub>	See Note 4	-20	_	_	μΑ
Input Mid Current	I <sub>IMM</sub>	See Note 4	-2		+2	μA
Input High Current	I <sub>IHH</sub>	See Note 4	_	_	20	μA
NI. C.						

- 1. Current draw is independent of supply voltage
- 2. No under- or overshoot is allowed.
- 3. LVPECL outputs require nominal VDD ≥ 2.5 V.
- **4.** This is the amount of leakage that the 3-Level inputs can tolerate from an external driver. See Si53xx Family Reference Manual for more details.
- 5. LVPECL, CML, LVDS and low-swing LVDS measured with Fo = 622.08 MHz.

### **Table 1. DC Characteristics (Continued)**

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, T_A = -40 \text{ to } 85 \text{ °C})$ 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
LVCMOS Output Pins								
Output Voltage Low	V <sub>OL</sub>	IO = 2 mA V <sub>DD</sub> = 1.71 V	_	_	0.4	V		
Output Voltage Low		IO = 2 mA V <sub>DD</sub> = 2.97 V	_	_	0.4	V		
Output Voltage High	V <sub>OH</sub>	IO = -2 mA V <sub>DD</sub> = 1.71 V	V <sub>DD</sub> – 0.4	_	_	V		
Output Voltage High		IO = -2 mA V <sub>DD</sub> = 2.97 V	V <sub>DD</sub> – 0.4	_	_	V		
Disabled Leakage Current	I <sub>OZ</sub>	RSTb = 0	-100	_	100	μA		

- 1. Current draw is independent of supply voltage
- 2. No under- or overshoot is allowed.
- 3. LVPECL outputs require nominal VDD ≥ 2.5 V.
- 4. This is the amount of leakage that the 3-Level inputs can tolerate from an external driver. See Si53xx Family Reference Manual for more details.
- 5. LVPECL, CML, LVDS and low-swing LVDS measured with Fo = 622.08 MHz.

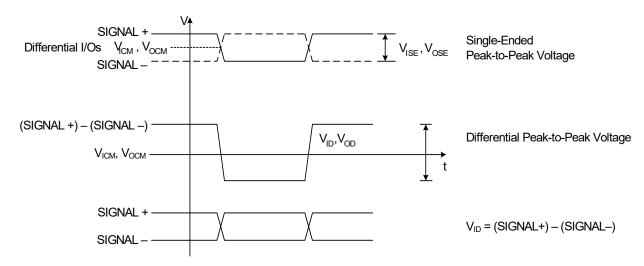


Figure 1. Differential Voltage Characteristics

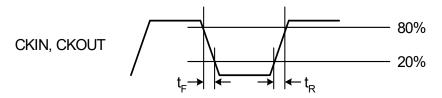


Figure 2. Rise/Fall Time Characteristics

**Table 2. AC Specifications** 

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, T_A = -40 \text{ to } 85 \text{ °C})$ 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
CKINn Input Pins				•		
Input Frequency	CKN <sub>F</sub>		19.44	_	707.35	MHz
Input Duty Cycle (Minimum Pulse Width)	CKN <sub>DC</sub>	Whichever is smaller (i.e., the 40% / 60% limitation applies only to high frequency clocks)	40	_	60	%
			2	_	_	ns
Input Capacitance	CKN <sub>CIN</sub>		_	_	3	pF
Input Rise/Fall Time	CKN <sub>TRF</sub>	20–80% See Figure 2	_	_	11	ns
CKOUTn Output Pins				1	1	1
(See ordering section for	or speed grad	e vs frequency limits)				
Output Frequency (Output not config- ured for CMOS or Disabled)	CKO <sub>F</sub>		19.44	_	1050	MHz
Maximum Output Frequency in CMOS Format	CKO <sub>F</sub>		_	_	212.5	MHz
Output Rise/Fall (20–80 %) @ 622.08 MHz output	CKO <sub>TRF</sub>	Output not configured for CMOS or Disabled See Figure 2	_	230	350	ps
Output Rise/Fall (20–80%) @ 212.5 MHz output	CKO <sub>TRF</sub>	CMOS Output V <sub>DD</sub> = 1.71 C <sub>LOAD</sub> = 5 pF	_	_	8	ns
Output Rise/Fall (20–80%) @ 212.5 MHz output	CKO <sub>TRF</sub>	CMOS Output V <sub>DD</sub> = 2.97 C <sub>LOAD</sub> = 5 pF	_	_	2	ns
Output Duty Cycle Uncertainty @ 622.08 MHz	CKO <sub>DC</sub>	100 Ω Load Line-to-Line Measured at 50% Point (Not for CMOS)	_	_	+/-40	ps

<sup>8</sup> Skyworks Solutions, Inc. • Phone [781] 376-3000 • Fax [781] 376-3100 • sales@skyworksinc.com • www.skyworksinc.com
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Table 2. AC Specifications (Continued) (V<sub>DD</sub> = 1.8  $\pm$  5%, 2.5  $\pm$ 10%, or 3.3 V  $\pm$ 10%, T<sub>A</sub> = -40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
LVCMOS Input Pins						•
Minimum Reset Pulse Width	t <sub>RSTMN</sub>		1			μs
Input Capacitance	C <sub>in</sub>		_	_	3	pF
LVCMOS Output Pins						
Rise/Fall Times	t <sub>RF</sub>	C <sub>LOAD</sub> = 20pf See Figure 2	_	25	_	ns
LOSn Trigger Window	LOS <sub>TRIG</sub>	From last CKINn ↑ to LOS↑	_	_	750	μs
Device Skew						
Output Clock Skew	t <sub>SKEW</sub>	↑ of CKOUTn to ↑ of CKOUT_m, C	_	_	100	ps
Phase Change due to Temperature Variation	t <sub>TEMP</sub>	Max phase changes from –40 to +85 °C	_	300	500	ps
PLL Performance (fin=fout = 622.08 MHz	BW-120 U-	·· I VDECI )				
`		, LVPEGL)				T .5
Closed Loop Jitter Peaking	J <sub>PK</sub>		_	0.05	0.1	dB
Jitter Tolerance	$J_{TOL}$	Jitter Frequency ≥ Loop Bandwidth	5000/BW	_	_	ns pk-pk
Phase Noise fout = 622.08 MHz		1 kHz Offset	_	-90	_	dBc/Hz
10ut – 022.08 WII 12	0140	10 kHz Offset	_	-113	_	dBc/Hz
	CKO <sub>PN</sub>	100 kHz Offset	_	-118	_	dBc/Hz
		1 MHz Offset	_	-132	_	dBc/Hz
Spurious Noise	SP <sub>SPUR</sub>	Max spur @ n x f3 (n ≥ 1, n x f3 < 100 MHz)	_	-93	<del>-</del> 70	dBc

**Table 3. Jitter Generation** 

Parameter	Symbol	Test Condition*		Min	Тур	Max	Unit
		Measurement Filter	DSPLL BW <sup>2</sup>				
Jitter Gen OC-192	JGEN	4–80 MHz	120 Hz	_	.23	_	ps <sub>rms</sub>
		0.05–80 MHz	120 Hz	_	.47	_	ps <sub>rms</sub>
Jitter Gen OC-48	JGEN	0.12-20 MHz	120 Hz	_	.48	_	ps <sub>rms</sub>

\*Note: Test conditions:

1.flN = fOUT = 622.08 MHz 2.Clock input: LVPECL 3.Clock output: LVPECL 4.PLL bandwidth: 877 kHz

 $5.V_{DD} = 3.3 V$  $6.T_{A} = 85 °C$ 

### **Table 4. Thermal Characteristics**

(V<sub>DD</sub> = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%,  $T_A$  = –40 to 85 °C)

Parameter	Symbol	Test Condition	Value	Unit
Thermal Resistance Junction to Ambient	$\theta_{\sf JA}$	Still Air	40	C°/W

**Table 5. Absolute Maximum Limits** 

Parameter	Symbol	Value	Unit	
DC Supply Voltage	$V_{DD}$	-0.5 to 3.8	V	
LVCMOS Input Voltage	$V_{DIG}$	-0.3 to (V <sub>DD</sub> + 0.3)	V	
CKINn Voltage Level Limits	CKN <sub>VIN</sub>	0 to V <sub>DD</sub>	V	
XA/XB Voltage Level Limits	XA <sub>VIN</sub>	0 to 1.2	V	
Operating Junction Temperature	T <sub>JCT</sub>	-55 to 150	С	
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	С	
ESD HBM Tolerance (100 pF, 1.5 kΩ); All pins except CKIN+/CKIN–		2	kV	
ESD MM Tolerance; All pins except CKIN+/CKIN–		150	V	
ESD HBM Tolerance (100 pF, 1.5 kΩ); CKIN+/CKIN–		700	V	
ESD MM Tolerance; CKIN+/CKIN–		100	V	
Latch-Up Tolerance		JESD78 Compliant		

**Note:** Permanent device damage may occur if the Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as specified in the operation sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.

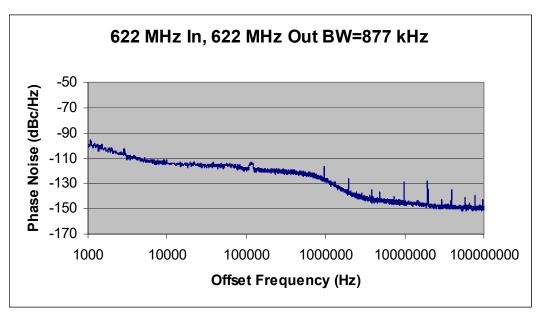
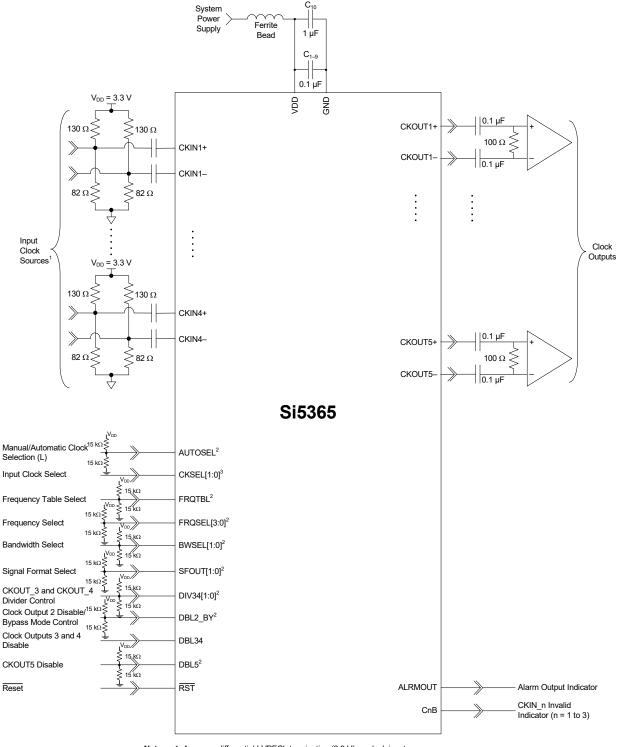


Figure 3. Typical Phase Noise Plot

Jitter Bandwidth	RMS Jitter (fs)
OC-48, 12 kHz to 20 MHz	374
OC-192, 20 kHz to 80 MHz	388
OC-192, 4 MHz to 80 MHz	181
OC-192, 50 kHz to 80 MHz	377
Broadband, 800 Hz to 80 MHz	420

# 2. Typical Application Schematic



Notes: 1. Assumes differential LVPECL termination (3.3 V) on clock inputs.

- 2. Denotes tri-level input pins with states designated as L (ground), M ( $V_{DD}/2$ ), and H ( $V_{DD}$ ).
- 3. Assumes manual input clock selection.

Figure 4. Si5365 Typical Application Circuit

## 3. Functional Description

The Si5365 is a low jitter, precision clock multiplier for high-speed communication systems, including SONET OC-48/OC-192, SDH STM-16/STM-64, Ethernet, and Fibre Channel, in which the application requires clock multiplication without jitter attenuation. The Si5365 accepts four clock inputs ranging from 19.44 to 707 MHz and generates five frequency-multiplied clock outputs ranging from 19.44 to 1050 MHz. By default the four clock inputs are at the same frequency and the five clock outputs are at the same frequency. Two of the output clocks can be divided down further to generate an integer sub-multiple frequency. The input clock frequency and clock multiplication ratio are selectable from a table of popular SONET, Ethernet, and Fibre Channel frequencies. In addition to providing clock multiplication in SONET and datacom applications, the supports SONET-to-datacom frequency translations. Skyworks Solutions offers a PC-based software utility, DSPLLsim, that can be used to look up valid Si5365 frequency translations.

This utility can be downloaded from https://www.sky-worksinc.com/en/Products/Timing (click on Documentation).

The Si5365 is based on Skyworks Solutions' 3rd-generation DSPLL® technology, which provides any-frequency synthesis in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The Si5365 PLL loop bandwidth is digitally programmable via the BWSEL[1:0] pins and supports a range from 150 kHz to 1.3 MHz. The DSPLLsim software utility can be used to calculate valid loop bandwidth settings for a given input clock frequency/clock multiplication ratio.

The Si5365 monitors all input clocks for loss-of-signal and provides a LOS alarm when it detects a missing clock.

In the case when the input clocks enter alarm conditions, the PLL will freeze the DCO output frequency near its last value to maintain operation with an internal state close to the last valid operating state.

The Si5365 has five differential clock outputs. The signal format of the clock outputs is programmable to support LVPECL, LVDS, CML, or CMOS loads. If not required, unused clock outputs can be powered down to minimize power consumption. For system-level debugging, a bypass mode is available which drives the output clock directly from the input clock, bypassing the internal DSPLL. The device is powered by a single 1.8, 2.5, or 3.3 V supply.

### 3.1. Further Documentation

Consult the Skyworks Solutions Any-Frequency Precision Clock Family Reference Manual (FRM) for detailed information about the Si5365. Additional design support is available from Skyworks Solutions through your distributor.

Skyworks Solutions has developed a PC-based software utility called DSPLLsim to simplify device configuration, including frequency planning and loop bandwidth selection.

The FRM and this utility can be downloaded from https://www.skyworksinc.com/en/Products/Timing; click on Documentation.

## 4. Pin Descriptions: Si5365

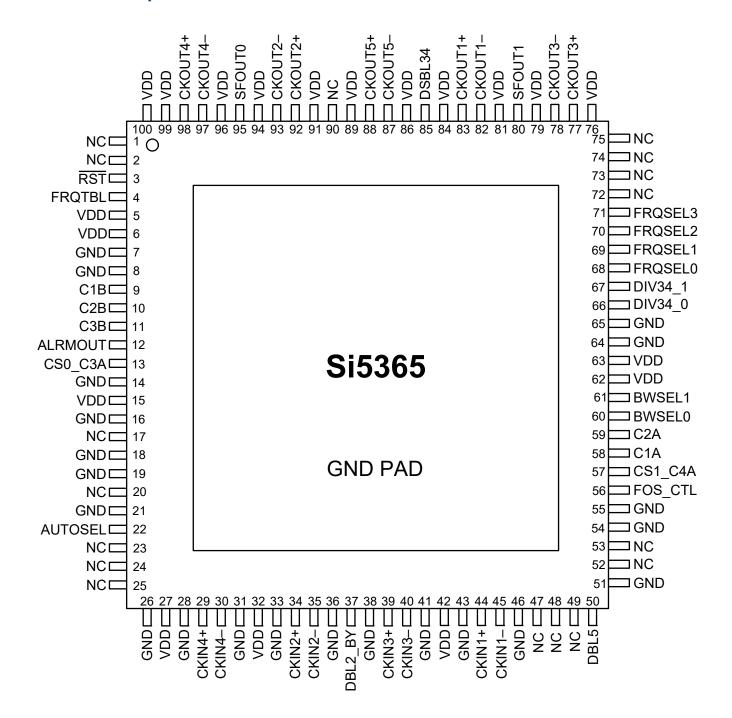


Table 6. Si5365 Pin Descriptions

Pin#	Pin Name	I/O	Signal Level	Description
1, 2, 17, 20, 23, 24, 25, 47, 48, 49, 52, 53, 72, 73, 74, 75, 90	NC			No Connect. These pins must be left unconnected for normal operation.
3	RST	I	LVCMOS	External Reset.  Active low input that performs external hardware reset of device.  Resets all internal logic to a known state and forces the device registers to their default value. Clock outputs are tristated during reset. After rising edge of RST signal, the device will perform an internal self-calibration.  This pin has a weak pullup.
4	FRQTBL	I	3-Level	Frequency Table Select. This pin selects SONET/SDH, datacom, or SONET/SDH to datacom frequency translation table. L = SONET/SDH. M = Datacom. H = SONET/SDH to Datacom. This pin has a weak pullup and weak pulldown and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
5, 6, 15, 27, 32, 42, 62, 63, 76, 79, 81, 84, 86, 89, 91, 94, 96, 99, 100	V <sub>DD</sub>	V <sub>DD</sub>	Supply	$V_{DD}$ . The device operates from a 1.8 or 2.5 V supply. Bypass capacitors should be associated with the following $V_{DD}$ pins:  Pins Bypass Cap 5, 6 0.1 μF 15 0.1 μF 27 0.1 μF 62, 63 0.1 μF 76, 79 1.0 μF 81, 84 0.1 μF 86, 89 0.1 μF 91, 94 0.1 μF
7, 8, 14, 16, 18, 19, 21, 26, 28, 31, 33, 36, 38, 41, 43, 46, 51, 54, 55, 56, 64, 65	GND	GND	Supply	Ground. These pins must be connected to system ground. Minimize the ground path impedance for optimal performance.

Table 6. Si5365 Pin Descriptions (Continued)

Pin#	Pin Name	I/O	Signal Level		Desc	cription	
9	C1B	0	LVCMOS	CKIN1 Invalid Indicator.  This pin is an active high alarm output associated with CKIN1. Once triggered, the alarm will remain high until CKIN1 is validated.  0 = No alarm on CKIN1.  1 = Alarm on CKIN1.			
10	C2B	0	LVCMOS	CKIN2 Invalid Indicator.  This pin is an active high alarm output associated with CKIN2. Once triggered, the alarm will remain high until CKIN2 is validated.  0 = No alarm on CKIN2.  1 = Alarm on CKIN2.			
11	СЗВ	0	LVCMOS	CKIN3 Invalid In This pin is an act 0 = No alarm on 1 = Alarm on CK	tive high alarm ou CKIN3.	itput associated with CKI	N3.
12	ALRMOUT	0	LVCMOS	Alarm Output Indicator. This pin is an active high alarm output associated with CKIN4 or the frame sync alignment alarm.  0 = ALRMOUT not active.  1 = ALRMOUT active.			
13 57	CS0_C3A CS1_C4A	I/O	LVCMOS	Input Clock Select/CKINn Active Clock Indicator. Input: If manual clock selection mode is chosen (AUTOSEL = 1), the CS[1:0] pins function as the manual input clock selector control.			
					CS[1:0]	Active Input Clock	
					00	CKIN1	
					01	CKIN2	
					10	CKIN3	
					11	CKIN4	
				These inputs are internally deglitched to prevent inadvertent clock switching during changes in the CSn input state. If configured as input, these pins must not float.  Output: If automatic clock detection is chosen (AUTOSEL = M or H), these pins function as the CKINn active clock indicator output. 0 = CKINn is not the active input clock.  1 = CKINn is currently the active input clock to the PLL. This pin has a weak pulldown.			
22	AUTOSEL	I	3-Level	Manual/Automatic Clock Selection. Three level input that selects the method of input clock selection to be used. L = Manual. M = Automatic non-revertive. H = Automatic revertive. This pin has a weak pullup and weak pulldown and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.			

Table 6. Si5365 Pin Descriptions (Continued)

Pin#	Pin Name	I/O	Signal Level	Description
29 30	CKIN4+ CKIN4-	I	MULTI	Clock Input 4. Differential clock input. This input can also be driven with a single-ended signal.
34 35	CKIN2+ CKIN2-	I	MULTI	Clock Input 2.  Differential input clock. This input can also be driven with a single-ended signal.
37	DBL2_BY	ı	3-Level	CKOUT2 Disable/PLL Bypass Mode Control.  Controls enable of CKOUT2 divider/output buffer path and PLL bypass mode.  L = CKOUT2 Enabled.  M = CKOUT2 Disabled.  H = BYPASS Mode with CKOUT2 enabled. Bypass is not available with CMOS outputs.  This pin has a weak pullup and weak pulldown and defaults to M.  Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
39 40	CKIN3+ CKIN3-	İ	MULTI	Clock Input 3.  Differential clock input. This input can also be driven with a single-ended signal.
44 45	CKIN1+ CKIN1-	I	MULTI	Clock Input 1.  Differential clock input. This input can also be driven with a single-ended signal.
50	DBL5	I	3-Level	CKOUT5 Disable.  This pin performs the following functions:  L = Normal operation. Output path is active and signal format is determined by SFOUT inputs.  M = CMOS signal format. Overrides SFOUT signal format to allow CKOUT5 to operate in CMOS format while the clock outputs operate in a differential output format.  H = Powerdown. Entire CKOUT5 divider and output buffer path is powered down. CKOUT5 output will be in tristate mode during powerdown. This pin has a weak pullup and weak pulldown and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
56	FOS_CTL	I	3-Level	Frequency Offset Control.  This pin enables or disables use of the CKIN2 FOS reference as an input to the clock selection state machine.  L = FOS Disabled.  M = Stratum 3/3E FOS Threshold.  H = SONET Minimum Clock FOS Threshold.  This pin has both weak pullups and weak pulldowns and defaults to M.  Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
58	C1A	0	LVCMOS	CKIN1 Active Clock Indicator.  This pin serves as the CKIN1 active clock indicator.  0 = CKIN1 is not the active input clock.  1 = CKIN1 is currently the active input clock to the PLL.

Table 6. Si5365 Pin Descriptions (Continued)

Pin#	Pin Name	I/O	Signal Level	Description
59	C2A	0	LVCMOS	CKIN2 Active Clock Indicator.  This pin serves as the CKIN2 active clock indicator.  0 = CKIN2 is not the active input clock.  1 = CKIN2 is currently the active input clock to the PLL.
60 61	BWSEL0 BWSEL1	I	3-Level	Bandwidth Select. These pins are three level inputs that select the DSPLL closed loop bandwidth according to the Any-Frequency Precision Clock Family Reference Manual. These pins have both weak pullups and weak pulldowns and default to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
66 67	DIV34_0 DIV34_1		3-Level	CKOUT3 and CKOUT4 Divider Control.  These pins control the division of CKOUT3 and CKOUT4 relative to the CKOUT2 output frequency. Detailed operations and timing characteristics for these pins may be found in the Any-Frequency Precision Clock Family Reference Manual.  These pins have both weak pullups and weak pulldowns and default to M.  Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
68 69 70 71	FRQSEL1 FRQSEL2 FRQSEL3	I	3-Level	Multiplier Select. These pins are three level inputs that select the input clock and clock multiplication setting according to the Any-Frequency Precision Clock Family Reference Manual, depending on the FRQTBL setting. These pins have both weak pullups and weak pulldowns and default to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
77 78	CKOUT3+ CKOUT3-	0	MULTI	Clock Output 3.  Differential output clock with a frequency specified by FRQSEL and FRQTBL settings. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.

Table 6. Si5365 Pin Descriptions (Continued)

Pin#	Pin Name	I/O	Signal Level	Description			
80 95	SFOUT1 SFOUT0	I	3-Level		ts that select the or rential swing) for	output signal format (com all of the clock outputs e	
				,	SFOUT[1:0]	Signal Format	
					HH	Reserved	
					НМ	LVDS	
					HL	CML	
					MH	LVPECL	
					MM	Reserved	
					ML	LVDS—Low Swing	
					LH	CMOS	
					LM	Disable	
					LL	Reserved	
82	CKOUT1-	0	MULTI	Bypass mode is not available with CMOS outputs. When VDD = 3.3 V, for thermal reasons, there are restrictions on the number of LVPECL and CMOS outputs. See the Si53xx-RM reference manual for details. These pins have both weak pullups and weak pulldowns and default to M.  Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.  Clock Output 1.			
83	CKOUT1+			Differential output clock with a frequency specified by FRQSEL and FRQTBL. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.			
85	DBL34	I	LVCMOS	Output 3 and 4 Disable.  Active high input. When active, entire CKOUT3 and CKOUT4 divider and output buffer path is powered down. CKOUT3 and CKOUT4 outputs will be in tristate mode during powerdown.  This pin has a weak pullup.			
87 88	CKOUT5+	0	MULTI	Clock Output 5. Fifth high-speed clock output with a frequency specified by FRQSEL and FRQTBL. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.			
92 93	CKOUT2+ CKOUT2-	0	MULTI	Clock Output 2.  Differential output clock with a frequency specified by FRQSEL and FRQTBL. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.			

# Table 6. Si5365 Pin Descriptions (Continued)

Pin#	Pin Name	I/O	Signal Level	Description
97 98	CKOUT4- CKOUT4+	0		Clock Output 4.  Differential output clock with a frequency specified by FRQSEL and FRQTBL settings. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.
GND PAD	GND PAD	GND		<b>Ground Pad</b> .  The ground pad must provide a low thermal and electrical impedance to a ground plane.

# 5. Ordering Guide

Ordering Part Number	Package	ROHS6, Pb-Free	Temperature Range		
Si5365-C-GQ*	100-Pin 14 x 14 mm TQFP	Yes	–40 to 85 °C		
*Note: Not recommended for new designs. For alternatives, see the Si533x family.					

# 6. Package Outline: 100-Pin TQFP

Figure 5 illustrates the package details for the Si5365. Table 7 lists the values for the dimensions shown in the illustration.

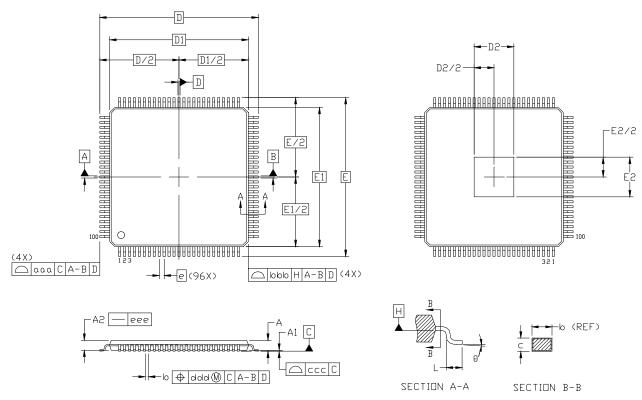


Figure 5. 100-Pin Thin Quad Flat Package (TQFP)

Table 7. 100-Pin Package Diagram Dimensions

Dimension	Min	Nom	Max	
А	_	_	1.20	
A1	0.05	_	0.15	
A2	0.95	1.00	1.05	
b	0.17	0.22	0.27	
С	0.09	_	0.20	
D	16.00 BSC.			
D1	14.00 BSC.			
D2	3.85	4.00	4.15	
е	0.50 BSC.			

Dimension	Min	Nom	Max	
E	16.00 BSC.			
E1	14.00 BSC.			
E2	3.85	4.00	4.15	
L	0.45	0.60	0.75	
aaa	_	_	0.20	
bbb	_	_	0.20	
ccc	_	_	0.08	
ddd	_	_	0.08	
Θ	0°	3.5°	7°	

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. This package outline conforms to JEDEC MS-026, variant AED-HD.
- Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

# 7. PCB Land Pattern

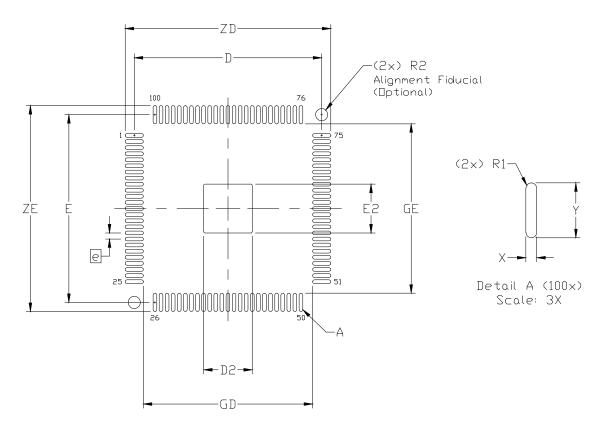


Figure 6. PCB Land Pattern Diagram

**Table 8. PCB Land Pattern Dimensions** 

Dimension	MIN	MAX		
е	0.50 E	0.50 BSC.		
E	15.40	REF.		
D	15.40	REF.		
E2	3.90	4.10		
D2	3.90	4.10		
GE	13.90	_		
GD	13.90	_		
Х	_	0.30		
Y	1.50 F	REF.		
ZE	_	16.90		
ZD	_	16.90		
R1	0.15 I	REF		
R2	_	1.00		

#### Notes:

#### General

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
- 3. This Land Pattern Design is based on IPC-7351 guidelines.
- **4.** All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

## Solder Mask Design

All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

#### Stencil Design

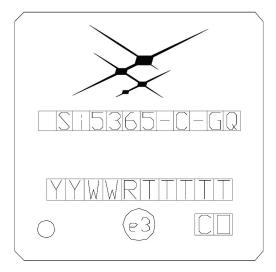
- **6.** A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 7. The stencil thickness should be 0.125 mm (5 mils).
- 8. The ratio of stencil aperture to land pad size should be 1:1 for the perimeter pads.
- 9. A 4 x 4 array of 0.80 mm square openings on 1.05 mm pitch should be used for the center ground pad.

#### **Card Assembly**

- 10. A No-Clean, Type-3 solder paste is recommended.
- **11.** The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

# 8. Top Marking

# 8.1. Si5365 Top Marking



# 8.2. Top Marking Explanation

Mark Method:	Laser	
Logo Size:	9.2 x 3.1 mm Center-Justified	
Font Size:	3.0 Point (1.07 mm) Right-Justified	
Line 1 Marking:	Device Part Number Si5365x-C-GQ	X = Speed Grade See "5. Ordering Guide" on page 21.
Line 2 Marking:	YY = Year WW = Workweek	Assigned by the Assembly Supplier. Corresponds to the year and workweek of the mold date.
	R = Die Revision	
	TTTTT = Mfg Code	Manufacturing Code
Line 3 Marking:	Circle = 1.8 mm Diameter Center-Justified	"e3" Pb-Free Symbol
	Country of Origin ISO Code Abbreviation	

## **DOCUMENT CHANGE LIST**

#### Revision 0.32 to Revision 0.33

Condensed format.

#### Revision 0.33 to Revision 0.34

- Removed references to latency control, INC, and DEC pins.
- Updated Table 1, "Performance Specifications," on page 2.
- Changed LVTTL to LVCMOS in Table 2, "Absolute Maximum Ratings," on page 3.
- Added Figure 1, "Typical Phase Noise Plot," on page 4.
- Updated Figure 4, "Si5365 Typical Application Circuit".
- Updated "4. Pin Descriptions: Si5365".
- Updated "5. Ordering Guide" on page 21.
- Added "7. PCB Land Pattern".

### Revision 0.34 to Revision 0.4

- Changed 1.8 V operating range to ±5%.
- Updated Table 1 on page 2.
- Updated Table 2 on page 3.
- Added page 4.
- Updated "3. Functional Description" on page 13.
- Clarified "4. Pin Descriptions: Si5365" on page 14 including the addition of FOS CTL (pin 56).

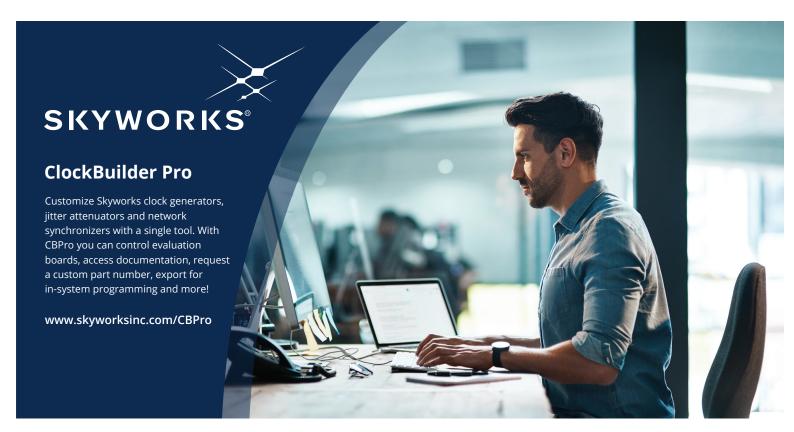
#### Revision 0.4 to Revision 0.5

- Changed "rate" to "frequency" throughout.
- Added Table of Contents.
- Reordered and expanded spec tables.
- Added 3.3 V operation.
- Added "8. Top Marking" on page 25.
- Added no bypass with CMOS outputs.
- Updated Table 2, "AC Specifications," on page 8.
- Updated Table 3, "Jitter Generation," on page 10.
- Updated "5. Ordering Guide" on page 21.

### Revision 0.5 to Revision 1.0

- Updated logo.
- Transitioned to full production.

**NOTES:** 









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ZL30237GGG2 SY100EL34LZG 9FGV1002BQ506LTGI AD9518-4ABCPZ MX852BB0030 PI6LC4840ZHE AD9516-4BCPZ-REEL7
AD9516-0BCPZ-REEL7 AD9574BCPZ-REEL7 PL602-21TC-R ZL30105QDG1 ZL30100QDG1 ZL30142GGG2